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Effect of Boundary Conditions on Drop Testing

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Motivation

Stage 2

• Situation : Current drop test

- Accelerometer and strain gage at a point are used to assure proper impact amplitude and duration.
- Doubtful board to board repeatability
- Drop impact life data tend to have big scatter

• Reasoning

- Complex nature of drop impact life assessment
- Various failure mode

Displacement Z Time: 0.2500 ms



Is that all?

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Are we comparing apple to apple?

Experimental conditions: Boundary Conditions ...



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Objectives

- Develop a non-contact 3D optical measurement technique by integrating high-speed cameras with 3D digital image correlation to characterize the *full-field* dynamic response of the board during drop impact.
- Characterize the effect of various boundary conditions on the PCB response experimentally.
 - Effect of tightening torque of mounting screws.
 - Effect of standoff height.
 - Effect of standoff stiffness evaluated by inserting a compressible material like rubber.



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JEDEC Drop Test



Outline

Introduction

- Experimental Setup and Test Procedures
- Experimental Results and Discussions
- Summary & Conclusions
- Acknowledgements



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Digital Image Correlation (DIC)

- An optical method to measure deformation on the surface of the specimen. Correlation of reference condition to a series of deformed conditions by tracking the changes in an applied micro pattern.
- The Intrinsic Measurement of 3D Coordinates of Virtual Gauge Boxes called Facets (or Subsets). Performs the image correlation algorithm: Pattern recognition, Sub-pixel interpolation and Coordinate triangulation.





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Integration of High-Speed Cameras



Boundary Conditions



1. Effect of Tightening

Applying a measured torque at all four Mounting screws of the standoff. Max. Permissible torque ~ 75 oz.-in. for this Design of standoff.

- Case 1: Tight Screw Case
 70 oz.-in. torque
- Case 2: Average tightening,
 40 oz.-in. torque
- Case 3: Loose Screw Case

5 oz.-in. torque



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Boundary Conditions



2. Effect of Rubber Shim

• Compressible material



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- Type: Circular cylindrical
- Thickness: 1.5 mm
- Outside diameter : 0.25"
- Inside diameter: based on Screw size of 4-40.

3. Effect of Standoff height



Hex Standoff like JEDEC

- Screw size: 4-40
- Type: Hex
- 18-8 Stainless steel
- Outside diameter : 0.25"
- Body length: ¹/₂"



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Measurement Results

<u>Full-Field Dynamic Data collected by high-speed cameras</u> <u>at average tightening torque</u>



Board Warpage Time-History

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Stage 2 Epsilon X Time: 0.2500 ms [%] 0.200 0.150 0.100 0.050 0.000 -0.050 -0.100-0.150-0.200 0.250 -0.300 BINGHAMTON ARAMIS

Longitudinal Strain Time-History



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Effect of Tightening Torque



• Tight Screw Case allows no relative motion Between the board and standoff.

• A modal analysis with all nodes at standoff Constrained for all DOF shows a frequency Close to tight-screw case.



Effect of Tightening Torque





Higher tightening restricts the ۲ relative motion between the board and the standoff.

The tighter torque case has about • 30% higher frequency compared to the loose case.



Effect of Standoff height





Greatly exaggerated bending of board

- Shorter standoffs tend to resist the board bending and so decrease the peak response and increase the cyclic frequency.
- About 13% decrease in the cyclic frequency for taller standoffs



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Effect of Standoff height



Effect of standoff height for Loose Case:

- Standoffs try to bend-in
 while the board
 undergoes vibrations due
 to drop impact.
- The effect of height of standoff is not significant for a 'Loose Case'.
- The 'Loose Torque' permits enough relative motion to offset the effect of standoff height.



Effect of Rubber Shim



Effect of Rubber shim on <u>Tight Case:</u>

- Rubber shim compresses, thereby enabling higher initial tightening
- The frequency starts relaxing with passing time. Meaning each bending cycle takes longer time to complete.
- The rate of decay in response magnitude is higher for 'rubber shim'

case.

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Summary and Conclusions

- A 3D non-contact optical measurement technique has been developed by integrating high-speed cameras with digital image correlation to accurately measure the *full-field* dynamic response of board during impact
- Effect of Boundary conditions were quantified
 - •Tightening torque resists the board bending. 'Tight screw' case has a frequency 30% higher compared to a loose screw case. Also the magnitude of response is larger for a 'Loose Screw' case.
 - Height of standoff contributes to the resistance of board in bending. Taller standoff gives a higher response magnitude and smaller cyclic bending frequency compared to a shorter standoff.
 - Standoff height had no effect on the bending frequency for really loose screw condition because of higher relative motion present due to lower tightening.
 - A compressible material like rubber lowers the cyclic frequency. Initially, the material allows higher tightening.



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